

LP2983 Micropower 150 mA Voltage Regulator in SOT-23 Package

For Output Voltages $\leq 1.2\text{V}$ Designed for Use with Very Low ESR Output Capacitors

Check for Samples: [LP2983](#)

FEATURES

- **Guaranteed 150 mA Output Current**
- **Smallest Possible Size (SOT-23 Package)**
- **Requires Minimum External Components**
- **Stable with Low-ESR Output Capacitor**
- **Low Ground Pin Current at All Loads**
- **Output Voltage Accuracy 1% (A Grade)**
- **High Peak Current Capability**
- **Wide Supply Voltage Range (16V Max)**
- **Low Z_{OUT} : 0.3Ω Typical (10 Hz to 1 MHz)**
- **Overtemperature/Overcurrent Protection**
- **-40°C to $+125^{\circ}\text{C}$ Junction Temperature Range**

APPLICATIONS

- Cellular Phone
- Palmtop/Laptop Computer
- Personal Digital Assistant (PDA)
- Camcorder, Personal Stereo, Camera

DESCRIPTION

The LP2983 is a 150 mA, fixed-output voltage regulator designed to provide tight voltage regulation in applications with output voltages $\leq 1.2\text{V}$.

Using an optimized VIP™ (Vertically Integrated PNP) process, the LP2983 delivers unequalled performance in all critical specifications:

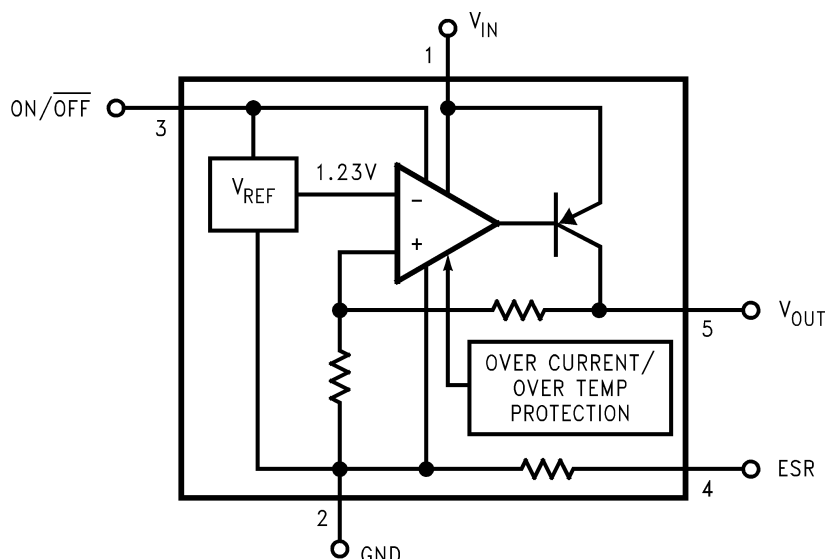
Ground Pin Current: Typically 825 μA @ 150 mA load, and 75 μA @ 1 mA load.

Enhanced Stability: The LP2983 is stable with output capacitor ESR down to zero, which allows the use of ceramic capacitors on the output.

Smallest Possible Size: SOT-23 package uses absolute minimum board space.

Precision Output: 1% tolerance output voltages available (A grade).

Block Diagram



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Connection Diagram

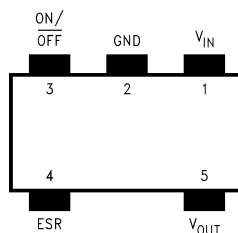


Figure 1. 5-Lead Small Outline Package (SOT-23)

Pin Functions

Pin Descriptions

Pin	Pin Number	Function
V _{IN}	1	Input Voltage
GND	2	Common Ground (device substrate)
ON/OFF	3	Logic high enable input
ESR	4	Low side connection for low-ESR output capacitors
V _{OUT}	5	Regulated Output Voltage



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

Absolute Maximum Ratings ⁽¹⁾

Storage Temperature Range	–65°C to +150°C
Operating Junction Temperature Range	–40°C to +125°C
Lead Temp. (Soldering, 5 sec.)	260°C
ESD Rating ⁽²⁾	2 kV
Power Dissipation ⁽³⁾	Internally Limited
Input Supply Voltage (Survival)	–0.3V to +16V
Input Supply Voltage (Operating)	2.2V to +16V
Shutdown Input Voltage (Survival)	–0.3V to +16V
Output Voltage Survival, ⁽⁴⁾	–0.3V to +9V
I _{OUT} (Survival)	Short Circuit Protected
Input-Output Voltage Survival, ⁽⁵⁾	–0.3V to +16V

- (1) "Absolute Maximum Ratings" indicate limits beyond which damage to the component may occur. Electrical specifications do not apply when operating the device outside of its rated operating conditions.
- (2) The ESD rating of pin 3 is 1 kV.
- (3) The maximum allowable power dissipation is a function of the maximum junction temperature, T_J(MAX), the junction-to-ambient thermal resistance, θ_{J-A}, and the ambient temperature, T_A. The maximum allowable power dissipation at any ambient temperature is calculated using:

$$P(\text{MAX}) = \frac{T_J(\text{MAX}) - T_A}{\theta_{JA}}$$
 Where the value of θ_{J-A} for the SOT-23 package is 240°C/W in a typical PC board mounting. Exceeding the maximum allowable dissipation will cause excessive die temperature, and the regulator will go into thermal shutdown.
- (4) If used in a dual-supply system where the regulator load is returned to a negative supply, the LP2983 output must be diode-clamped to ground.
- (5) The output PNP structure contains a diode between the V_{IN} to V_{OUT} terminals that is normally reverse-biased. Reversing the polarity from V_{IN} to V_{OUT} will turn on this diode and possibly cause a destructive latch-up condition (see Application Hints).

Electrical Characteristics

Limits in standard typeface are for $T_J = 25^\circ\text{C}$. and limits in **boldface type** apply over the full operating temperature range. Unless otherwise specified: $V_{IN} = V_O(\text{NOM}) + 1\text{V}$, $I_L = 1\text{ mA}$, $C_{IN} = 1\text{ }\mu\text{F}$, $C_{OUT} = 2.2\text{ }\mu\text{F}$, $V_{ON/OFF} = 2\text{V}$.

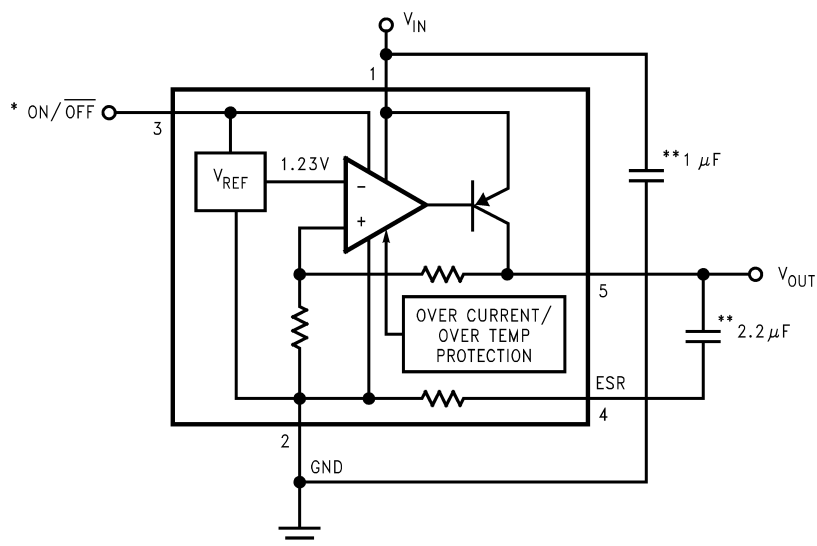
Symbol	Parameter	Conditions	Typ	LP2983AI-X.X		LP2983I-X.X		Units
				(1)		(1)		
				Min	Max	Min	Max	
ΔV_O	Output Voltage Tolerance			-1.0	1.0	-1.5	1.5	%
		$1\text{ mA} \leq I_L \leq 50\text{ mA}$		-2.0	2.0	-2.5	2.5	
				-2.5	2.5	-3.5	3.5	
		$1\text{ mA} \leq I_L \leq 150\text{ mA}$		-2.5	2.5	-3.0	3.0	
				-3.5	3.5	-4.0	4.0	
$\frac{\Delta V_O}{\Delta V_{IN}}$	Output Voltage	$V_O(\text{NOM})+1\text{V} \leq V_{IN} \leq 16\text{V}$	0.01		0.016		0.016	%/ V
	Line Regulation				0.032		0.032	
I_{GND}	Ground Pin Current	$I_L = 0$	65		95		95	μA
					125		125	
		$I_L = 1\text{ mA}$	75		110		110	
					170		170	
		$I_L = 10\text{ mA}$	120		220		220	
					400		400	
		$I_L = 50\text{ mA}$	300		500		500	
					900		900	
		$I_L = 150\text{ mA}$	825		1200		1500	
					2000		2000	
$V_{\text{IN}}(\text{min})$	Minimum V_{IN} required to maintain Output Regulation		2.05		2.20		2.20	V
$V_{\text{ON/OFF}}$	ON/OFF Input Voltage ⁽²⁾	High = O/P ON	1.4	1.6		1.6		
		Low = O/P OFF	0.1		0.05		0.05	
$I_{\text{ON/OFF}}$	ON/OFF Input Current	$V_{\text{ON/OFF}} = 0$	0.01		-2		-2	μA
		$V_{\text{ON/OFF}} = 5\text{V}$	5		15		15	
e_n	Output Noise	$\text{BW} = 10\text{ Hz to }100\text{ kHz},$						μV
	Voltage (RMS)	$C_{\text{OUT}} = 10\text{ }\mu\text{F}$	60					
		$V_{\text{OUT}} = 1.2\text{V}$						
$\frac{\Delta V_{\text{OUT}}}{\Delta V_{\text{IN}}}$	Ripple Rejection	$f = 1\text{ kHz}$	65					dB
		$C_{\text{OUT}} = 2.2\text{ }\mu\text{F}$						
$I_{\text{O}}(\text{SC})$	Short Circuit Current	$R_L = 0$ (Steady State)	400					mA
		⁽³⁾						
$I_{\text{O}}(\text{PK})$	Peak Output Current	$V_{\text{OUT}} \geq V_{\text{O}}(\text{NOM}) - 5\%$	250					

(1) Limits are 100% production tested at 25°C . Limits over the operating temperature range are guaranteed through correlation using Statistical Quality Control (SQC) methods. The limits are used to calculate National's Average Outgoing Quality Level (AOQL).

(2) The ON/OFF input must be properly driven to prevent possible misoperation. For details, refer to Application Hints.

(3) The LP2983 has foldback current limiting which allows a high peak current when $V_{OUT} > 0.5\text{V}$, and then reduces the maximum output current as V_{OUT} is forced down to ground (see Typical Performance Characteristics curves).

Typical Application Circuit



*ON/OFF input must be actively terminated. Tie to V_{IN} if this function is not to be used.

**Minimum capacitance is shown to ensure stability (may be increased without limit). Ceramic capacitor required for output (see Application Hints).

Typical Performance Characteristics

Unless otherwise specified: $C_{IN} = 1\mu\text{F}$, $C_{OUT} = 2.2\mu\text{F}$, $V_{IN} = V_{OUT}(\text{NOM}) + 1$, $T_A = 25^\circ\text{C}$, ON/OFF pin is tied to V_{IN} .

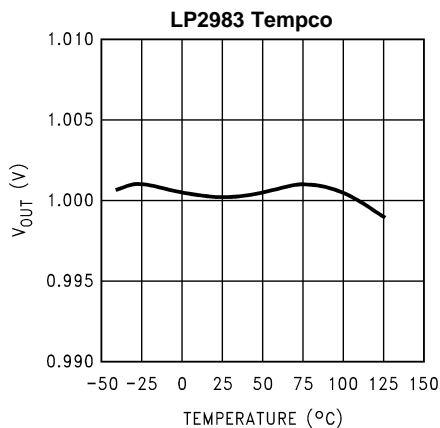


Figure 2.

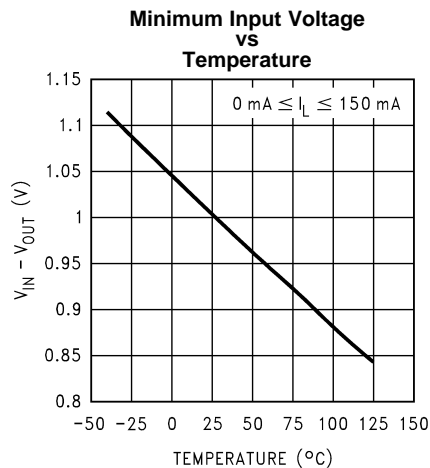


Figure 3.

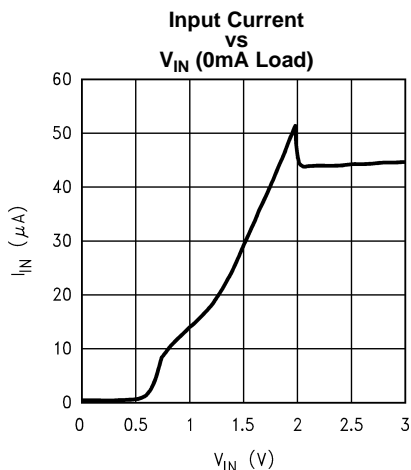


Figure 4.

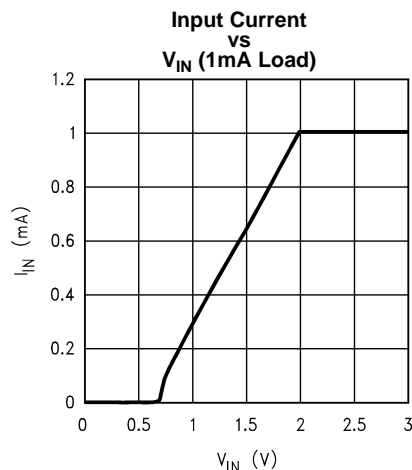


Figure 5.

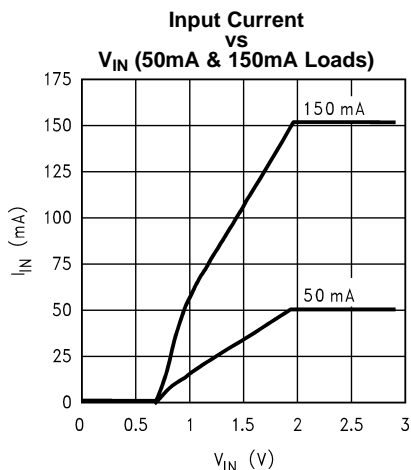


Figure 6.

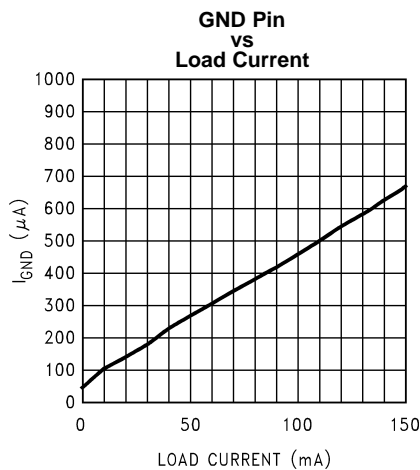


Figure 7.

Typical Performance Characteristics (continued)

Unless otherwise specified: $C_{IN} = 1\mu F$, $C_{OUT} = 2.2\mu F$, $V_{IN} = V_{OUT(NOM)} + 1$, $T_A = 25^\circ C$, ON/OFF pin is tied to V_{IN} .

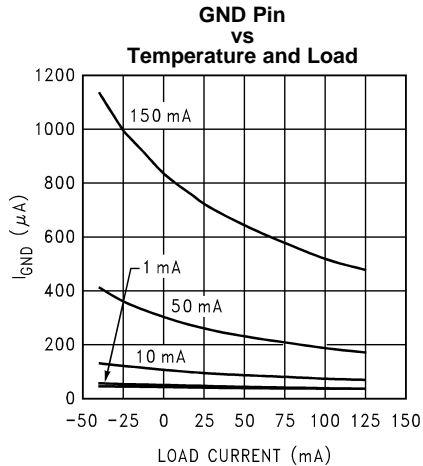


Figure 8.

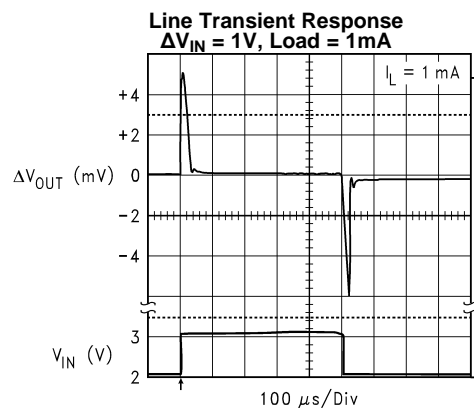


Figure 9.

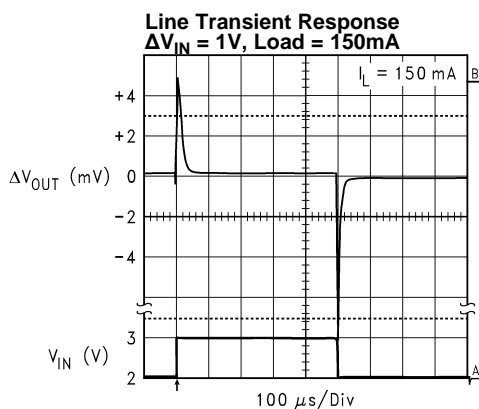


Figure 10.

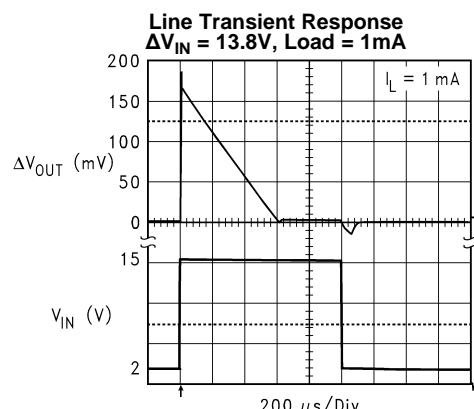


Figure 11.

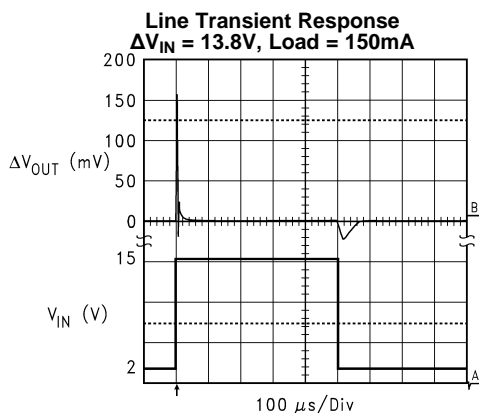


Figure 12.

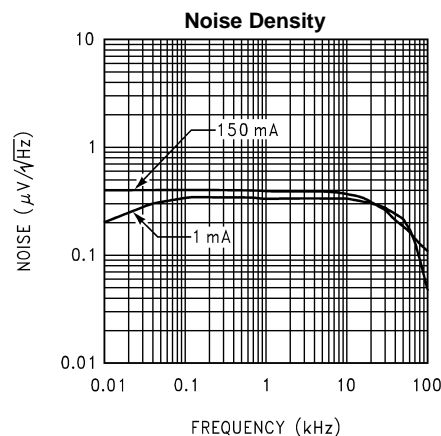


Figure 13.

Typical Performance Characteristics (continued)

Unless otherwise specified: $C_{IN} = 1\mu F$, $C_{OUT} = 2.2\mu F$, $V_{IN} = V_{OUT(NOM)} + 1$, $T_A = 25^\circ C$, ON/OFF pin is tied to V_{IN} .

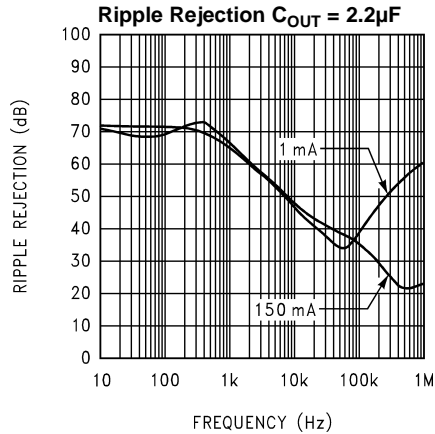


Figure 14.

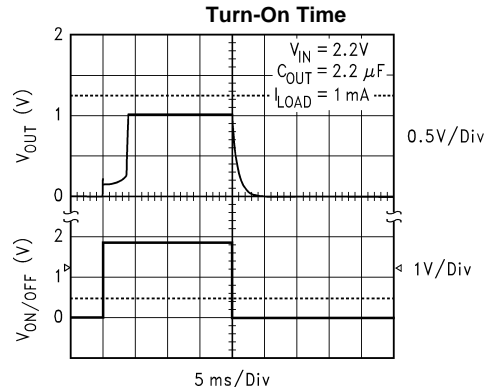


Figure 15.

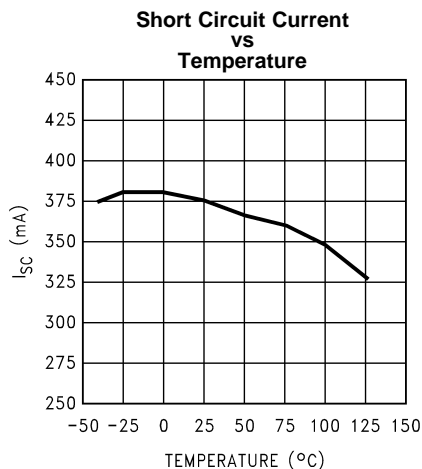


Figure 16.

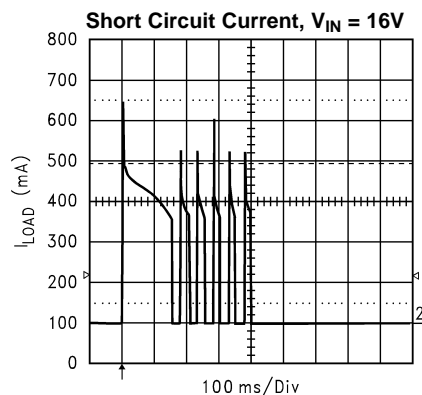


Figure 17.

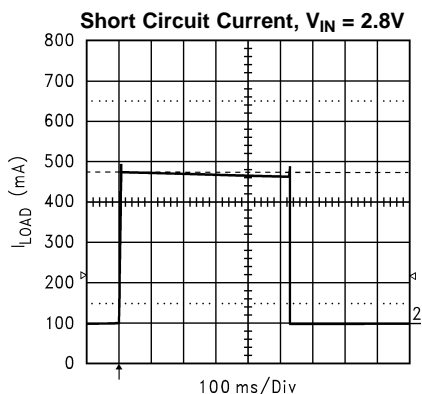


Figure 18.

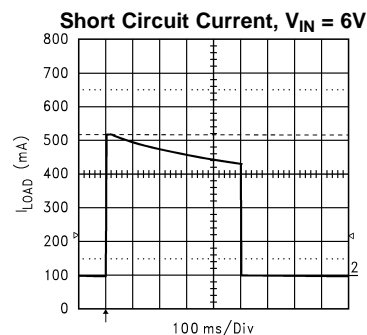


Figure 19.

Typical Performance Characteristics (continued)

Unless otherwise specified: $C_{IN} = 1\mu\text{F}$, $C_{OUT} = 2.2\mu\text{F}$, $V_{IN} = V_{OUT}(\text{NOM}) + 1$, $T_A = 25^\circ\text{C}$, ON/OFF pin is tied to V_{IN} .

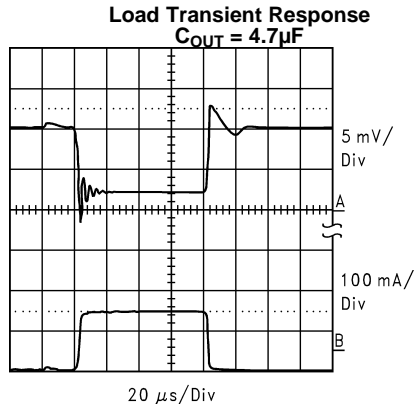


Figure 20.

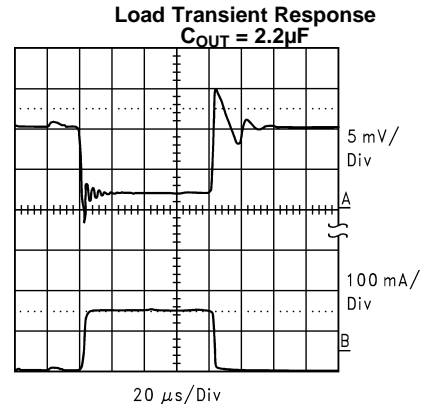


Figure 21.

Application Hints

EXTERNAL CAPACITORS

Like any low-dropout regulator, the LP2983 requires external capacitors for regulator stability. These capacitors must be correctly selected for good performance.

Input Capacitor

An input capacitor whose capacitance is $\geq 1\mu\text{F}$ is required between the LP2983 input and ground (the amount of capacitance may be increased without limit).

This capacitor must be located a distance of not more than 1 cm from the input pin and returned to a clean analog ground. Any good quality ceramic, tantalum, or film capacitor may be used at the input.

Important: Tantalum capacitors can suffer catastrophic failure due to surge current when connected to a low-impedance source of power (like a battery or very large capacitor). If a Tantalum capacitor is used at the input, it must be guaranteed by the manufacturer to have a surge current rating sufficient for the application.

There are no requirements for ESR on the input capacitor, but tolerance and temperature coefficient must be considered when selecting the capacitor to ensure the capacitance will be $\geq 1\mu\text{F}$ over the entire operating temperature range.

Output Capacitor

The LP2983 is designed specifically to work with ceramic output capacitors, utilizing circuitry which allows the regulator to be stable across the entire range of output current with an output capacitor whose ESR is as low as zero ohms.

The ceramic output capacitor must be connected between the V_{OUT} pin (device pin 5) and the ESR pin (device pin 4).

See [Figure 22](#) below.

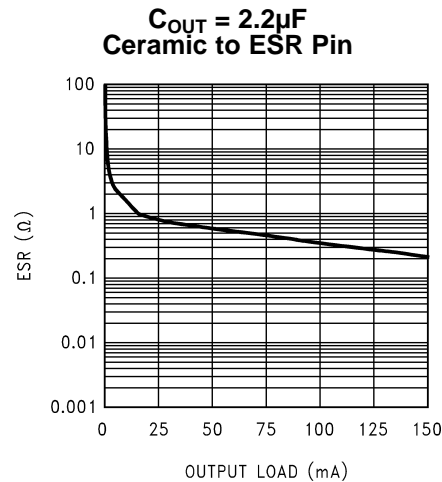


Figure 22.

The LP2983 requires a minimum of 2.2 μF on the output (output capacitor size can be increased without limit).

It is important to remember that capacitor tolerance and variation with temperature must be taken into consideration when selecting an output capacitor so that the minimum required amount of output capacitance is provided over the full operating temperature range. It should be noted that ceramic capacitors can exhibit large changes in capacitance with temperature (see next section, *Capacitor Characteristics*).

The output capacitor must be located not more than 1 cm from the output pin and returned to a clean analog ground via the ESR pin.

CAPACITOR CHARACTERISTICS

The LP2983 was designed to work with ceramic capacitors on the output to take advantage of the benefits they offer: for capacitance values in the 2.2 μF to 4.7 μF range, ceramics are the least expensive and also have the lowest ESR values (which makes them best for eliminating high-frequency noise).

One disadvantage of ceramic capacitors is that their capacitance can vary with temperature. Most large value ceramic capacitors ($\geq 2.2 \mu\text{F}$) are manufactured with the Z5U or Y5V temperature characteristic, which results in the capacitance dropping by more than 50% as the temperature goes from 25°C to 85°C.

This could cause problems if a 2.2 μF capacitor were used on the output since it will drop down to approximately 1 μF at high ambient temperatures (which could cause the LP2983 to oscillate). If Z5U or Y5V capacitors are used on the output, a minimum capacitance value of 4.7 μF must be observed.

A better choice for temperature coefficient in ceramic capacitors is X7R, which holds the capacitance within $\pm 15\%$. Unfortunately, the larger values of capacitance are not offered by all manufacturers in the X7R dielectric.

ON/OFF INPUT OPERATION

The LP2983 is shut off by driving the ON/OFF input low, and turned on by pulling it high. If this feature is not to be used, the ON/OFF input should be tied to V_{IN} to keep the regulator output on at all times.

To assure proper operation, the signal source used to drive the ON/OFF input must be able to swing above and below the specified turn-on/turn-off voltage thresholds listed in the Electrical Characteristics section under $V_{\text{ON/OFF}}$. To prevent mis-operation, the turn-on (and turn-off) voltage signals applied to the ON/OFF input must have a slew rate which is $\geq 40 \text{ mV}/\mu\text{s}$.

Caution: The regulator output voltage can not be guaranteed if a slow-moving AC (or DC) signal is applied that is in the range between the specified turn-on and turn-off voltages listed under the electrical specification $V_{\text{ON/OFF}}$ (see Electrical Characteristics).

REVERSE INPUT-OUTPUT VOLTAGE

The internal PNP power transistor used as the pass element in the LP2983 has an inherent diode connected between the regulator output and input. During normal operation (where the input voltage is higher than the output) this diode is reverse biased (See Figure 23).

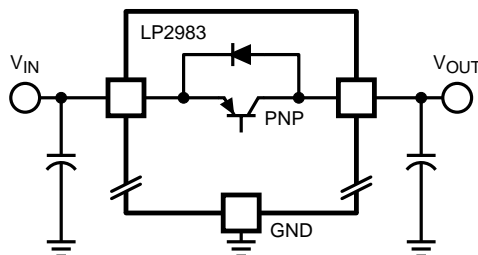


Figure 23. LP2983 Reverse Current Path

However, if the input voltage is more than a V_{BE} below the output voltage, this diode will turn ON and current will flow into the regulator output. In such cases, a parasitic SCR can latch which will allow a high current to flow into the V_{IN} pin and out the ground pin, which can damage the part.

The internal diode can also be turned on if the input voltage is abruptly stepped down to a voltage which is a V_{BE} below the output voltage.

In any application where the output voltage may be higher than the input voltage, an external Schottky diode must be connected from V_{IN} to V_{OUT} (cathode on V_{IN} , anode on V_{OUT}). See Figure 24, to limit the reverse voltage across the LP2982 to 0.3V (see *Absolute Maximum Ratings*).

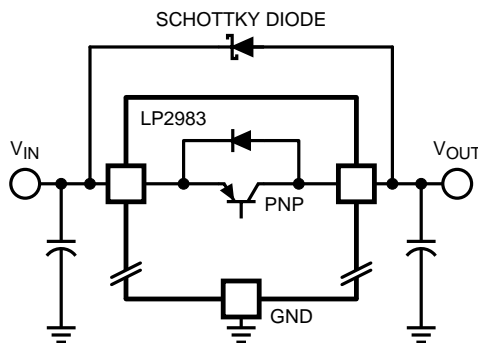


Figure 24. Adding External Schottky Diode Protection

REVISION HISTORY

Changes from Revision B (April 2013) to Revision C	Page
• Changed layout of National Data Sheet to TI format	10

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
LP2983AIM5-1.0/NOPB	ACTIVE	SOT-23	DBV	5	1000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LENA	Samples
LP2983AIM5-1.2/NOPB	ACTIVE	SOT-23	DBV	5	1000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LELA	Samples
LP2983AIM5X-1.0/NOPB	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LENA	Samples
LP2983AIM5X-1.2/NOPB	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LELA	Samples
LP2983IM5-1.0/NOPB	ACTIVE	SOT-23	DBV	5	1000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LENB	Samples
LP2983IM5-1.2	NRND	SOT-23	DBV	5	1000	TBD	Call TI	Call TI	-40 to 125	LELB	
LP2983IM5-1.2/NOPB	ACTIVE	SOT-23	DBV	5	1000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LELB	Samples
LP2983IM5X-1.0/NOPB	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LENB	Samples
LP2983IM5X-1.2/NOPB	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LELB	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

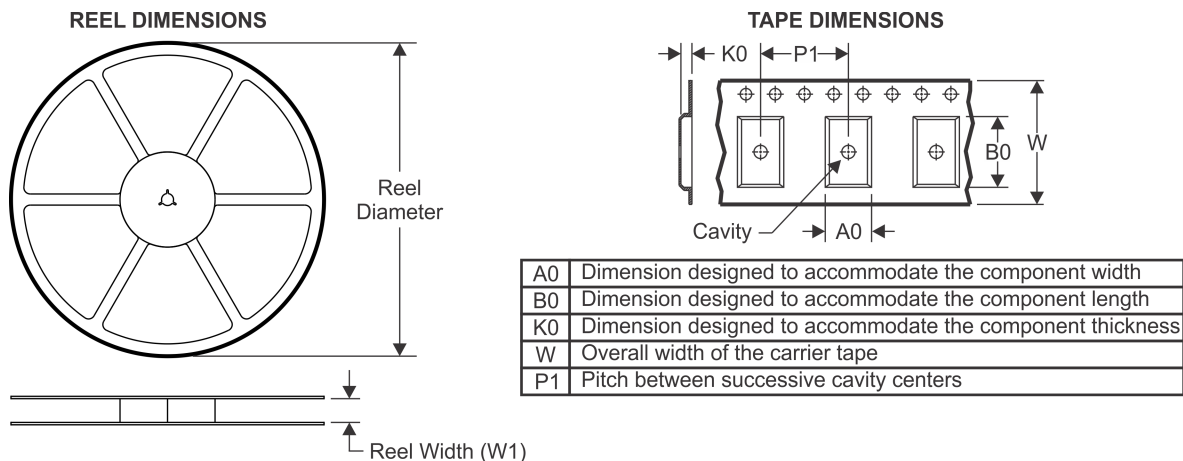
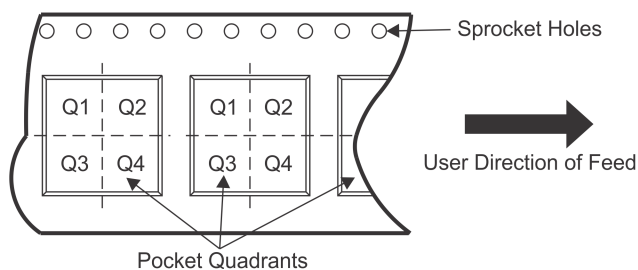
Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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TAPE AND REEL INFORMATION

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LP2983AIM5-1.0/NOPB	SOT-23	DBV	5	1000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP2983AIM5-1.2/NOPB	SOT-23	DBV	5	1000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP2983AIM5X-1.0/NOPB	SOT-23	DBV	5	3000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP2983AIM5X-1.2/NOPB	SOT-23	DBV	5	3000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP2983IM5-1.0/NOPB	SOT-23	DBV	5	1000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP2983IM5-1.2	SOT-23	DBV	5	1000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP2983IM5-1.2/NOPB	SOT-23	DBV	5	1000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP2983IM5X-1.0/NOPB	SOT-23	DBV	5	3000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP2983IM5X-1.2/NOPB	SOT-23	DBV	5	3000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3

TAPE AND REEL BOX DIMENSIONS

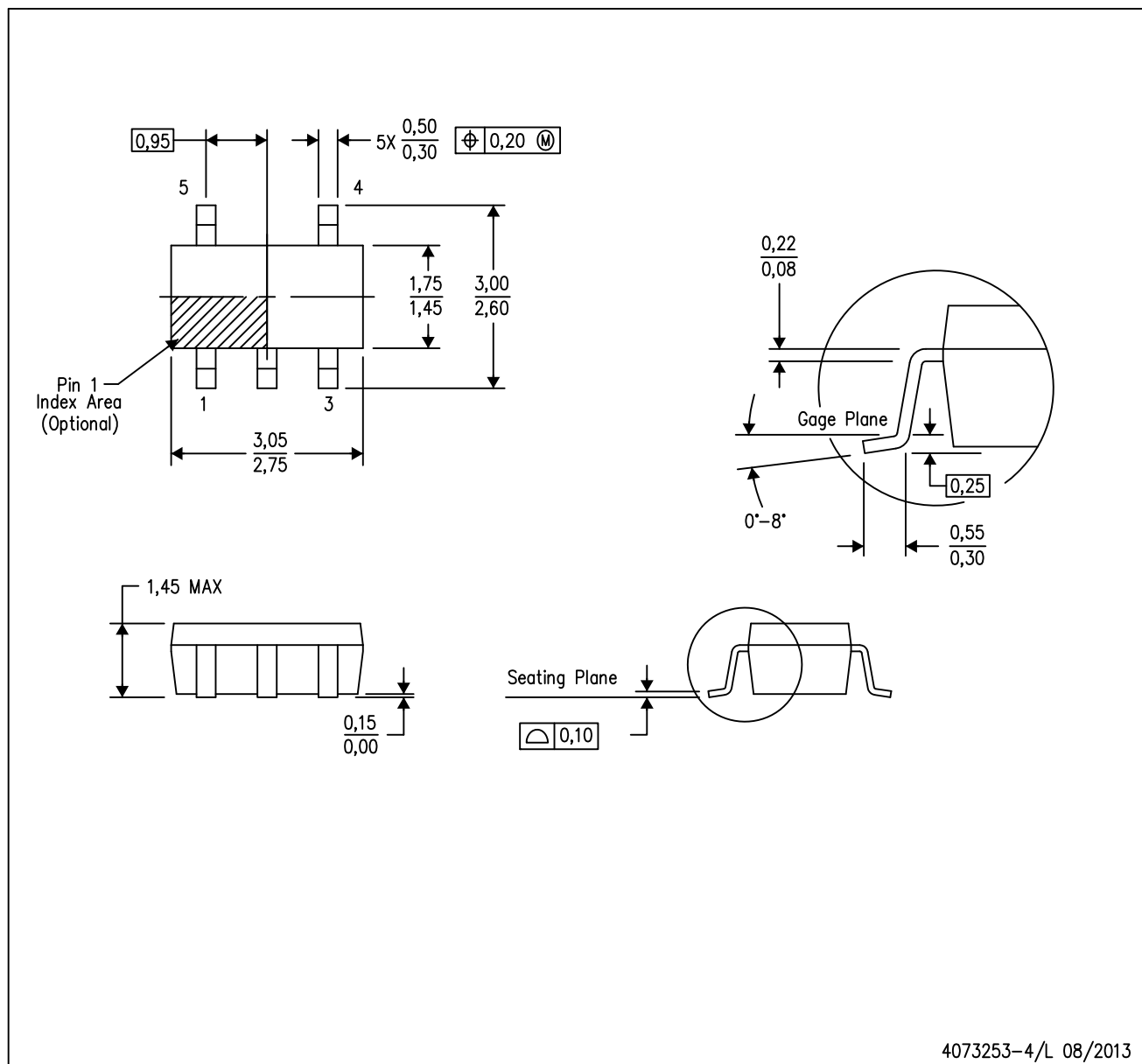


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LP2983AIM5-1.0/NOPB	SOT-23	DBV	5	1000	210.0	185.0	35.0
LP2983AIM5-1.2/NOPB	SOT-23	DBV	5	1000	210.0	185.0	35.0
LP2983AIM5X-1.0/NOPB	SOT-23	DBV	5	3000	210.0	185.0	35.0
LP2983AIM5X-1.2/NOPB	SOT-23	DBV	5	3000	210.0	185.0	35.0
LP2983IM5-1.0/NOPB	SOT-23	DBV	5	1000	210.0	185.0	35.0
LP2983IM5-1.2	SOT-23	DBV	5	1000	210.0	185.0	35.0
LP2983IM5-1.2/NOPB	SOT-23	DBV	5	1000	210.0	185.0	35.0
LP2983IM5X-1.0/NOPB	SOT-23	DBV	5	3000	210.0	185.0	35.0
LP2983IM5X-1.2/NOPB	SOT-23	DBV	5	3000	210.0	185.0	35.0

DBV (R-PDSO-G5)

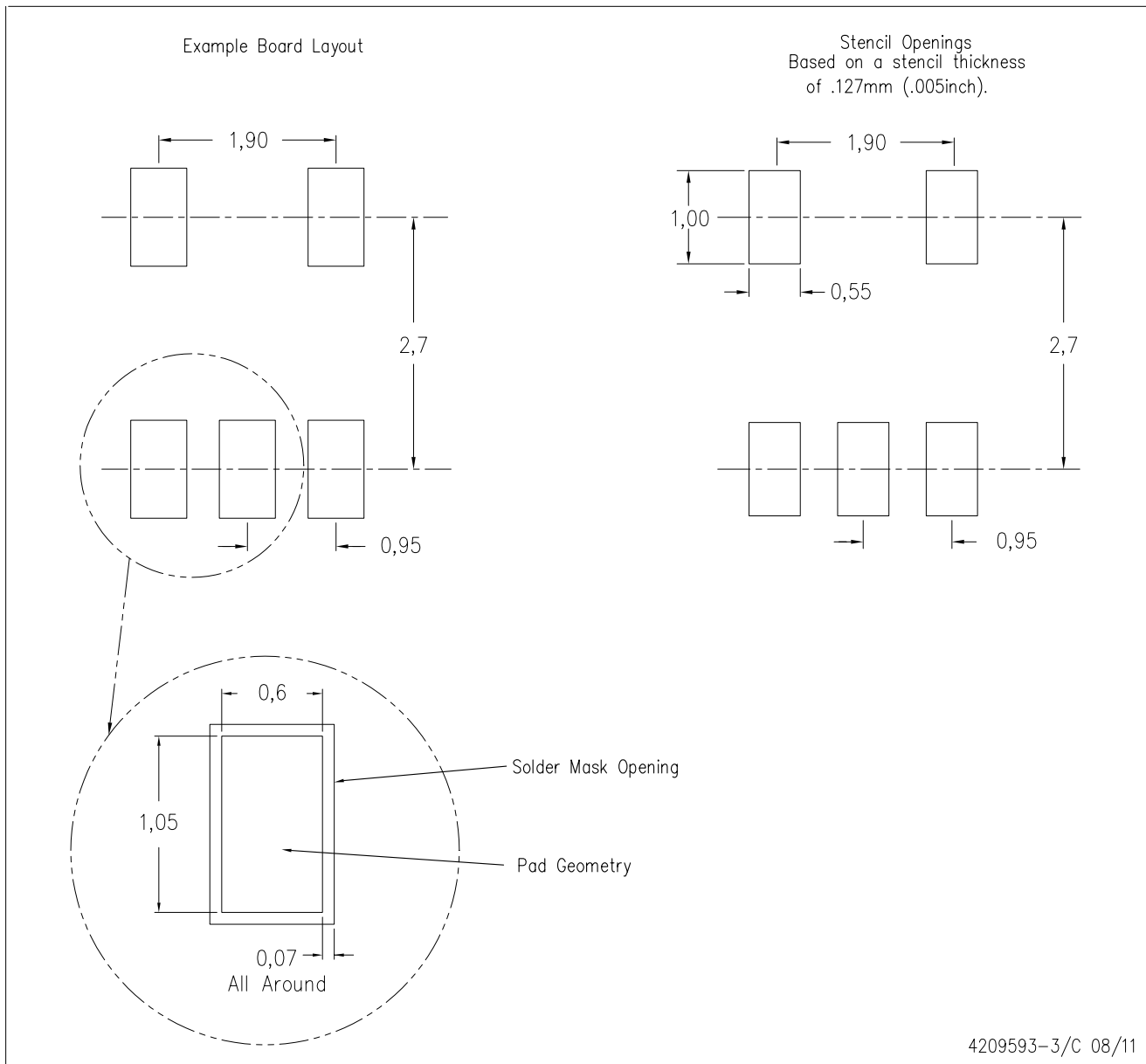
PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
 - D. Falls within JEDEC MO-178 Variation AA.

DBV (R-PDSO-G5)

PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Customers should place a note on the circuit board fabrication drawing not to alter the center solder mask defined pad.
 - D. Publication IPC-7351 is recommended for alternate designs.
 - E. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Example stencil design based on a 50% volumetric metal load solder paste. Refer to IPC-7525 for other stencil recommendations.

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